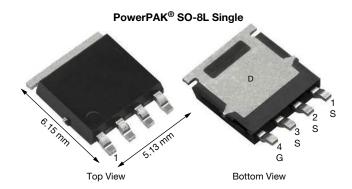


www.vishay.com

Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	-40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.0070			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0100			
I _D (A)	-60			
Configuration	Single			

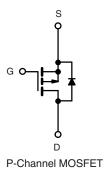
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % Rg and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJ409EP (for detailed order number please see www.vishay.com/doc?79771)

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	-40	V	
Gate-source voltage		V_{GS}	± 20	V	
Continuous drain current	T _C = 25 °C ^a		-60	А	
Continuous drain current	T _C = 125 °C	I _D	-42		
Continuous source current (diode conduction	n) ^a	I _S	-60		
Pulsed drain current b		I _{DM}	-150		
Single pulse avalanche current	J 0.1 ml J	I _{AS}	-41		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	84	mJ	
Maximum power dissipation ^b	T _C = 25 °C	Б	68	W	
	T _C = 125 °C	P_{D}	22		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	00	
Soldering recommendations (peak temperature) d, e			260	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount c	R_{thJA}	68	°C/W
Junction-to-case (drain)		R_{thJC}	2.2	C/VV

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	<u> </u>	_					
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = -250 μA	-40	-	-	.,
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = -250 μA	-1.5	-2.0	-2.5	V
Gate-source leakage	I _{GSS}	V _{DS} =	$0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = -40 V	-	-	-1	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 125 °C	-	-	-50	μΑ
		$V_{GS} = 0 V$	V _{DS} = -40 V, T _J = 175 °C	1	-	-150	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	V _{DS} ≥ -5 V	-30	-	-	Α
		V _{GS} = -10 V	I _D = -10 A	1	0.0058	0.0070	
Duning any way are state was interest 2		V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	-	0.0106	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	-	0.0126	Ω
		V _{GS} = -4.5 V	I _D = -6 A	1	0.0083	0.0100	
Forward transconductance b	9 _{fs}	V _{DS} =	-15 V, I _D = -10 A	-	54	-	S
Dynamic ^b							
Input capacitance	C _{iss}			-	8400	11 000	
Output capacitance	C _{oss}	$V_{GS} = 0 V$	$V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	=.	620	850	pF
Reverse transfer capacitance	C _{rss}			-	510	700	
Total gate charge ^c	Qg			-	170	260	
Gate-source charge c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -20 \text{ V}, I_{D} = -5 \text{ A}$	-	24	-	nC
Gate-drain charge ^c	Q_{gd}	7		-	35	-	
Gate resistance	Rg		f = 1 MHz	0.50	1.08	1.70	Ω
Turn-on delay time ^c	t _{d(on)}			-	23	35	
Rise time ^c	t _r	V _{DD} :	= -20 V, $R_L = 4 \Omega$	-	18	30	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong -5 \text{ A}, $	$V_{\rm GEN} = -10 \rm V, R_g = 1 \Omega$	-	75	120	ns
Fall time ^c	t _f			-	12	20	
Source-Drain Diode Ratings and Chara	acteristics ^b						
Pulsed current ^a	I _{SM}			=.	-	-150	Α
Forward voltage	V _{SD}	I _F =	-10 A, V _{GS} = 0 V	-	-0.76	-1.2	V
Body diode reverse recovery time	t _{rr}			-	39	90	ns
Body diode reverse recovery charge	Q _{rr}]	A di/dt 100 A/vo	-	45	100	nC
Reverse recovery fall time	ta	I _F = -10	A, di/dt = 100 A/μs	-	22	-	
Reverse recovery rise time	t _b	7		-	19	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-2.3	-	Α

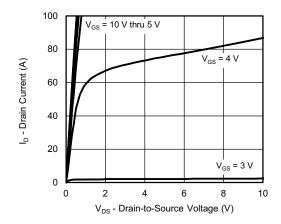
Notes

- f. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- g. Guaranteed by design, not subject to production testing
- h. Independent of operating temperature

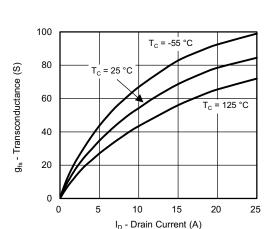
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



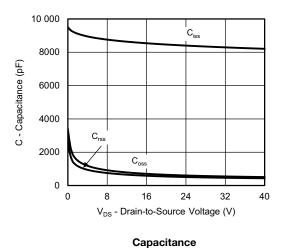
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

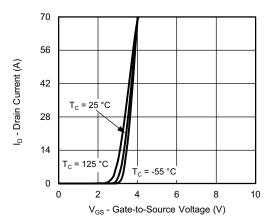


Output Characteristics

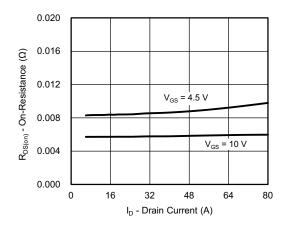


Transconductance

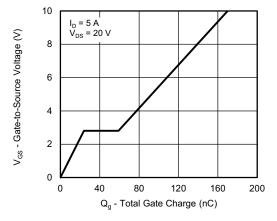




Transfer Characteristics



On-Resistance vs. Drain Current

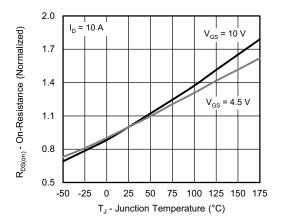


Gate Charge

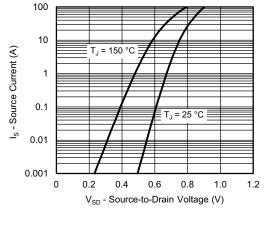
For technical questions, contact: automostechsu



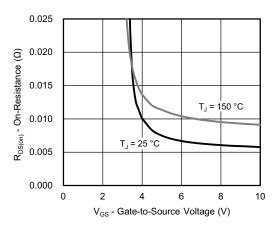
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



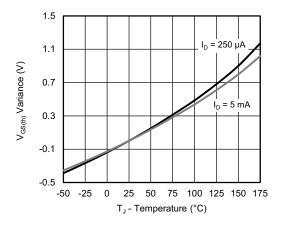
On-Resistance vs. Junction Temperature



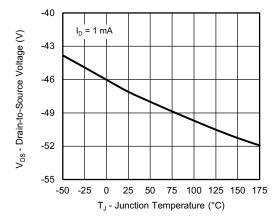
Source Drain Diode Forward Voltage



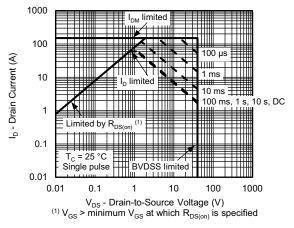
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Drain-Source Breakdown vs. Junction Temperature

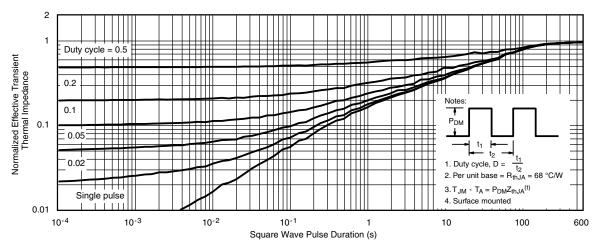


Safe Operating Area

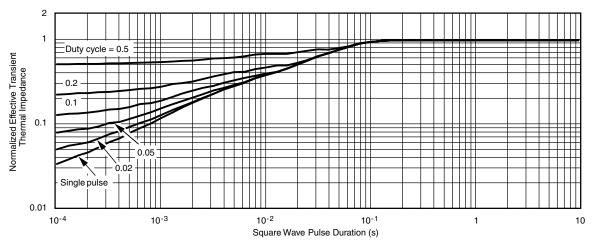
For technical questions, contact: automostech



THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

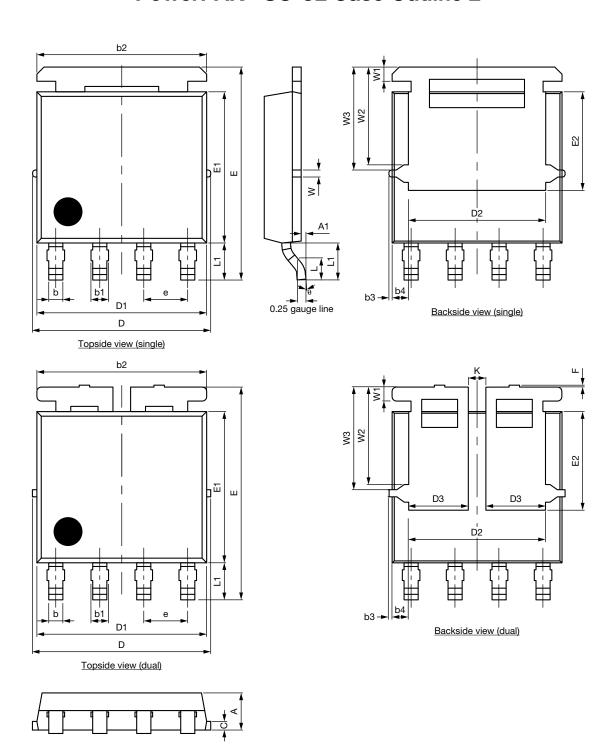
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C) - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77707.



PowerPAK® SO-8L Case Outline 2



Vishay Siliconix

DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	_		0.004	•	
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51	•	0.020			
W	0.23			0.009			
W1	0.41			0.016			
W2		2.82			0.111		
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: C21-1498-Rev. C, 01-Nov-2021

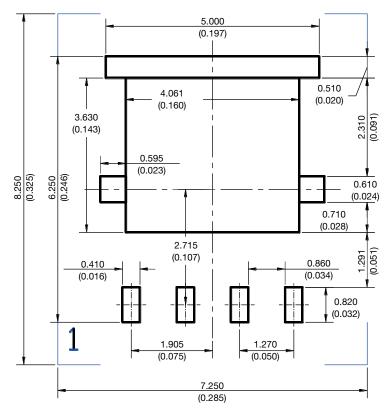
DWG: 6044

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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